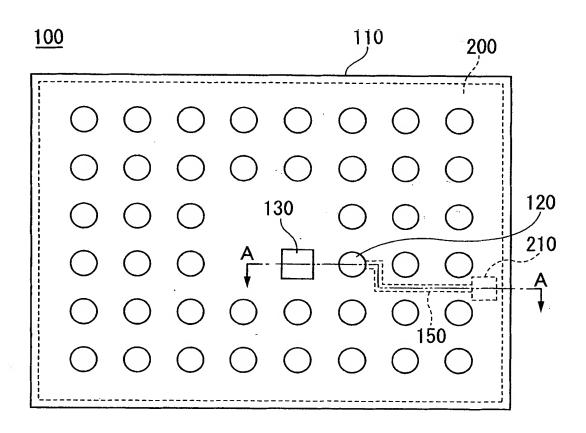
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FIG. 1

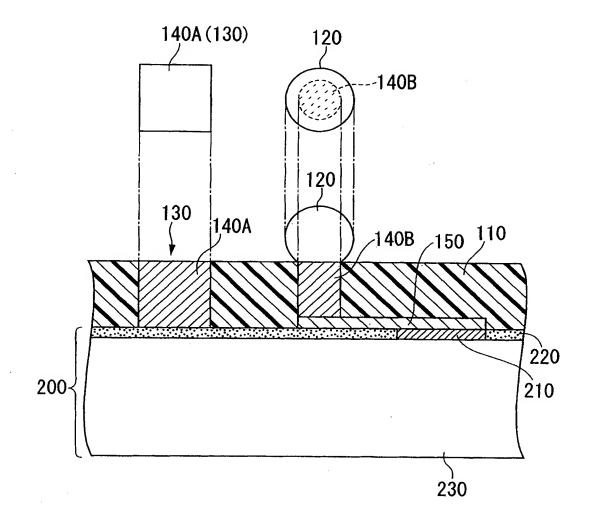


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FIG. 2

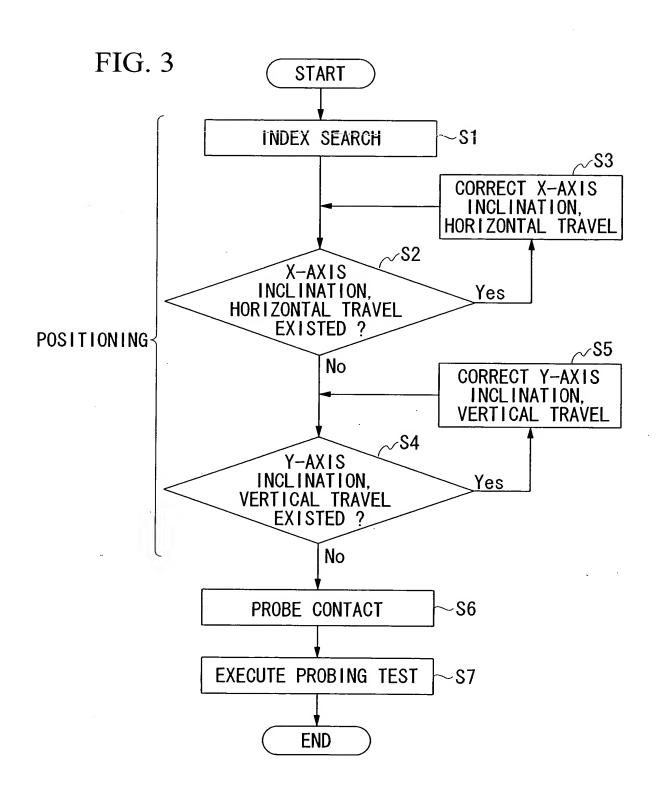


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FIG. 4A

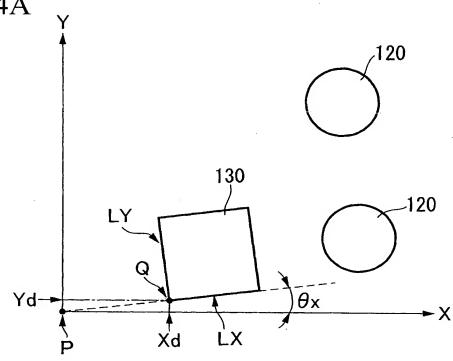
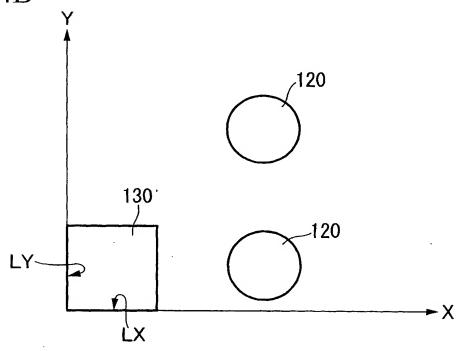


FIG. 4B

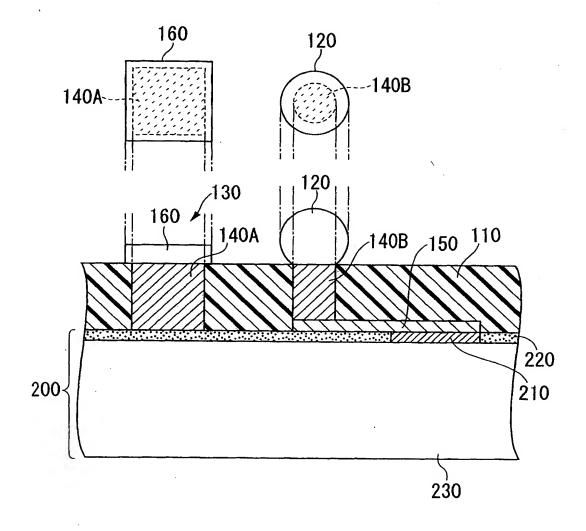


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FIG. 5

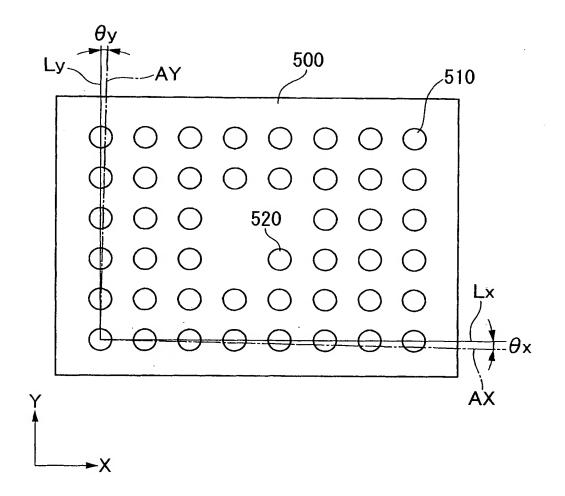


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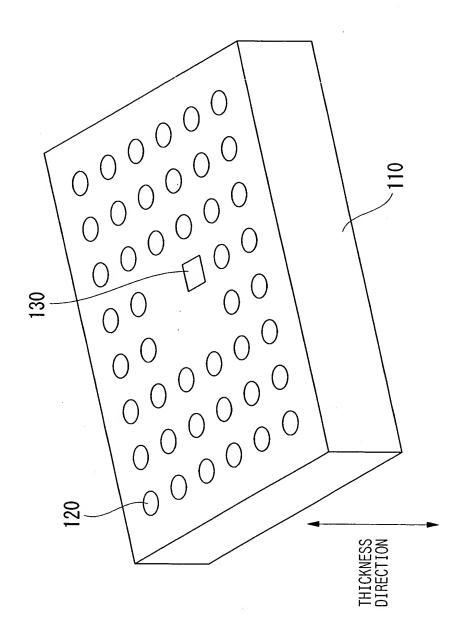
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FIG. 6



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FIG. 8

